

IRAM336-025SB3 Information



Part Number IRAM336-025SB3

Manufacturer Infineon Technologies

Category Discrete Semiconductor Products

Power Driver Modules

Description IC HYBRID MULTI-CHIP 500V 2A **Package** 19-PowerSSIP Module, Formed Leads

For the pricing/inventory/lead time, please contact

us

For Reference Only

Website: https://www.heisener.com
E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









IRAM336-025SB3 Specifications

Manufacturer Part Number	IRAM336-025SB3
Manufacturer	Infineon Technologies
Category	Discrete Semiconductor Products
	Power Driver Modules
Package	19-PowerSSIP Module, Formed Leads
Series	-
Туре	MOSFET
Configuration	3 Phase
Current	2A
Voltage	500V
Voltage - Isolation	-
Package / Case	19-PowerSSIP Module, Formed Leads
	Report errors?

IRAM336-025SB3 Guarantees



Quality Guarantees

We provide 90 days warranty. $\ensuremath{^*}$

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

IRAM336-025SB3 Payment Methods





















IRAM336-025SB3 Shipping Methods













If you have any question about IRAM336-025SB3, please do not hesitate to contact us!

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